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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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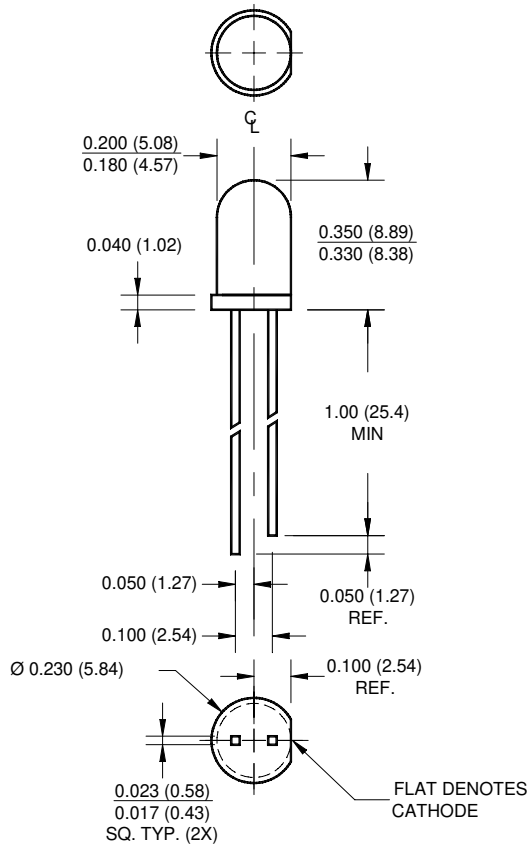
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# SUPER BRIGHT T-1 3/4 (5 mm) LED LAMP - Water Clear

## PACKAGE DIMENSIONS



### NOTES:

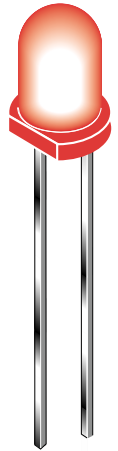
1. Dimensions for all drawings are in inches (mm).
2. Lead spacing is measured where the leads emerge from the package.
3. Protruded resin under the flange is 1.5 mm (0.059") max.

**SUPER RED**  
**MV8003 MV8004**  
**MV8005**

**MV800X**

## FEATURES

- Popular T-1 3/4 package
- Super high brightness suitable for outdoor applications
- Solid state reliability
- Water clear optics
- Standard 100 mil. lead spacing



## DESCRIPTION

This T-1 3/4 super bright LED has a moderate viewing angle of 20° for concentrated light output. The MV800X series is made with an AlInGaP LED that emits red light at 640 nm. It is encapsulated in a water clear epoxy lens package.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Rating	Unit
Operating Temperature	T <sub>OPR</sub>	-40 to +100	°C
Storage Temperature	T <sub>STG</sub>	-40 to +100	°C
Lead Soldering Time	T <sub>SOL</sub>	260 for 5 sec	°C
Continuous Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current (f = 1.0 KHz, Duty Factor = 1/10)	I <sub>F</sub>	160	mA
Reverse Voltage	V <sub>R</sub>	5	V
Power Dissipation	P <sub>D</sub>	85	mW

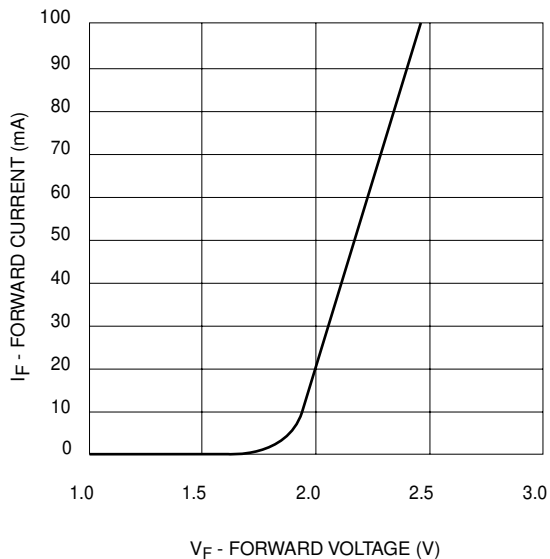
# SUPER BRIGHT T-1 3/4 (5 mm) LED LAMP - Water Clear

<b>SUPER RED</b>	<b>MV800X</b>
<b>MV8003 MV8004</b>	
<b>MV8005</b>	

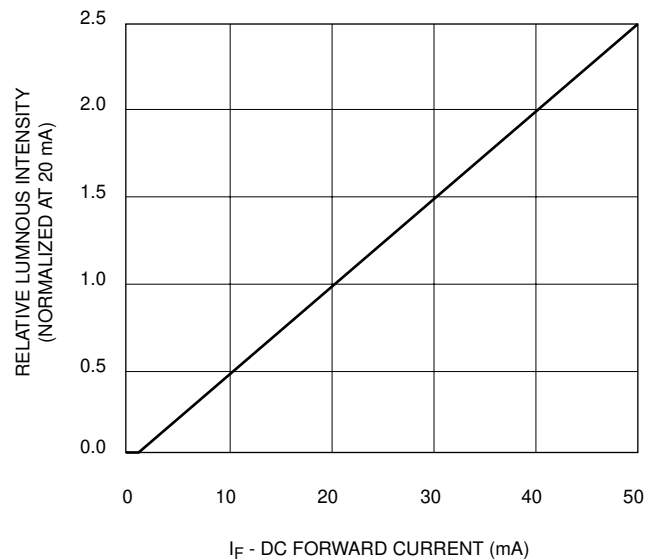
## ELECTRICAL / OPTICAL CHARACTERISTICS (T<sub>A</sub> =25°C)

Part Number	MV8003	MV8004	MV8005	Condition
Luminous Intensity (mcd)				I <sub>F</sub> = 20mA
Minimum	630	1000	1600	
Typical	940	1500	2400	
Forward Voltage (V)				I <sub>F</sub> = 20mA
Maximum	2.8	2.8	2.8	
Typical	2.1	2.1	2.1	
Peak Wavelength (nm)	640	640	640	I <sub>F</sub> = 20mA
Spectral Line Half Width (nm)	20	20	20	I <sub>F</sub> = 20mA
Viewing Angle (°)	20	20	20	I <sub>F</sub> = 20mA

## TYPICAL PERFORMANCE CURVES



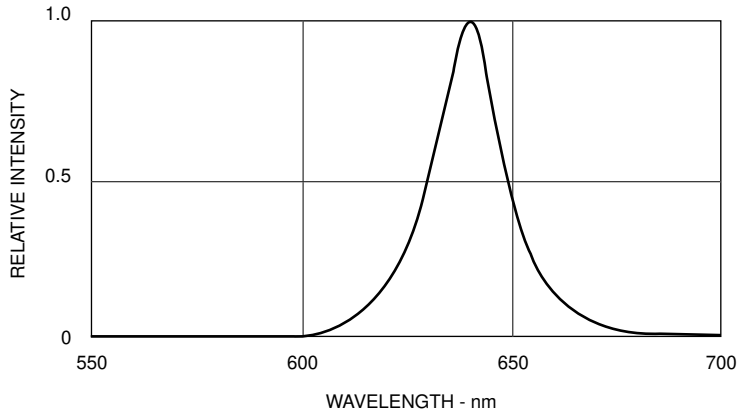
**Fig. 1 Forward Current vs. Forward Voltage**



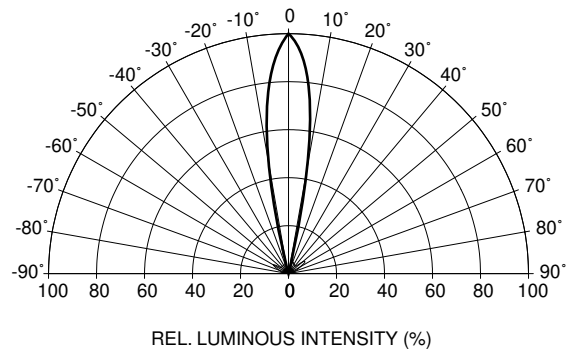
**Fig. 2 Relative Luminous Intensity vs. DC Forward Current**

# SUPER BRIGHT T-1 3/4 (5 mm) LED LAMP - Water Clear

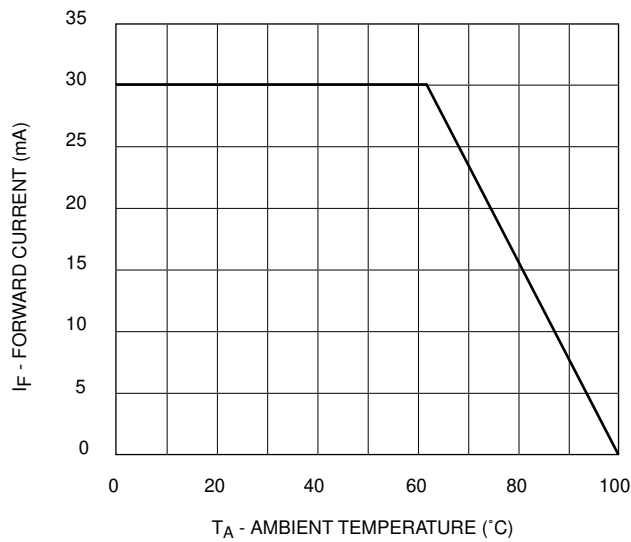
<b>SUPER RED</b>	<b>MV800X</b>
<b>MV8003 MV8004</b>	
<b>MV8005</b>	



**Fig. 3 Relative Intensity vs Peak Wavelength**



**Fig. 4 Radiation Diagram**



**Fig. 5 Current Derating Curve**

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